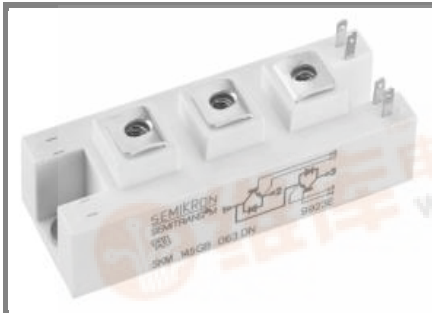


SKM 195GB124DN



SEMITRANS™ 2N

Low Loss IGBT Modules

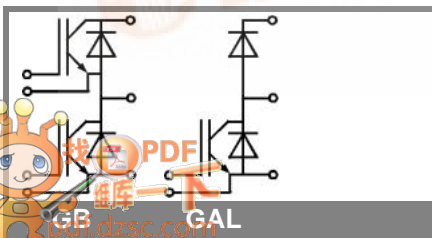
SKM 195GB124DN
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Features

- N channel, homogeneous Silicon structure NPT-IGBT (Non punch-through)
- Low saturation voltage
- Low inductance case
- Low tail current with low temperature dependence
- High short circuit capability, self limiting to $6 \times I_{cnom}$
- Fast & soft inverse CAL diodes
- Without hard mould
- Large clearance (10 mm) and creepage distance (20 mm)

Typical Applications

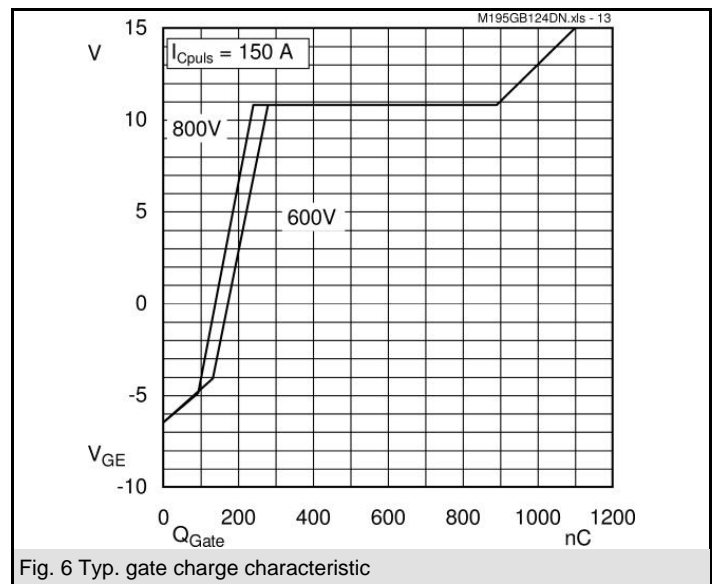
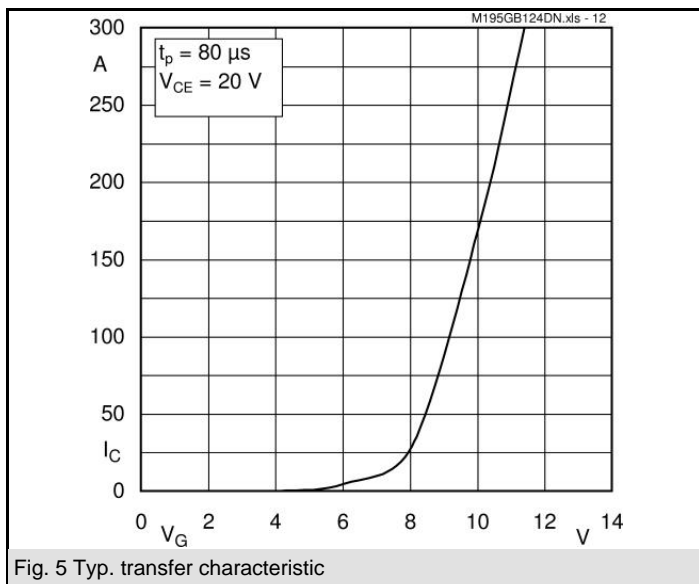
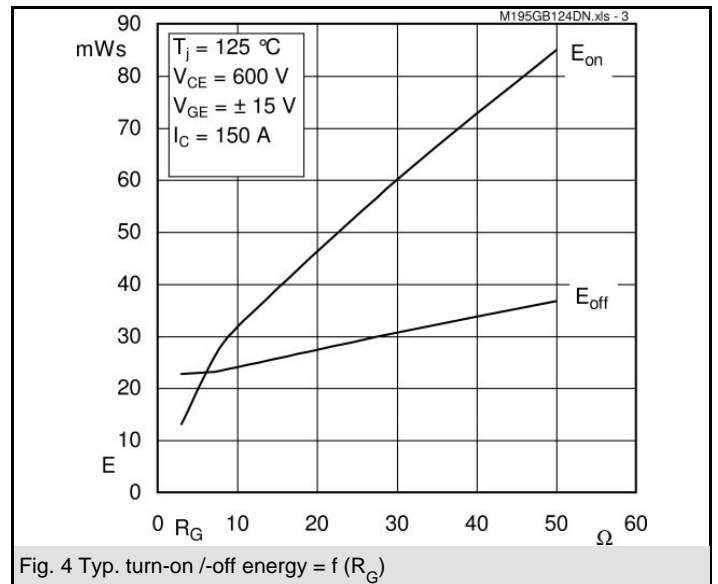
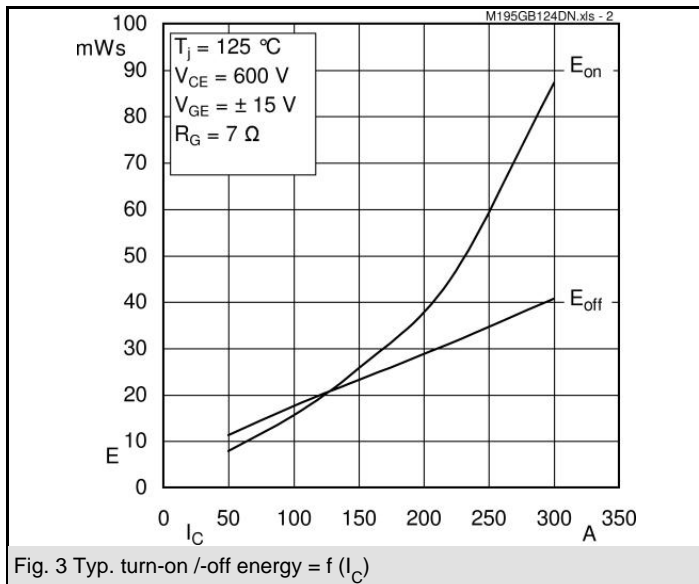
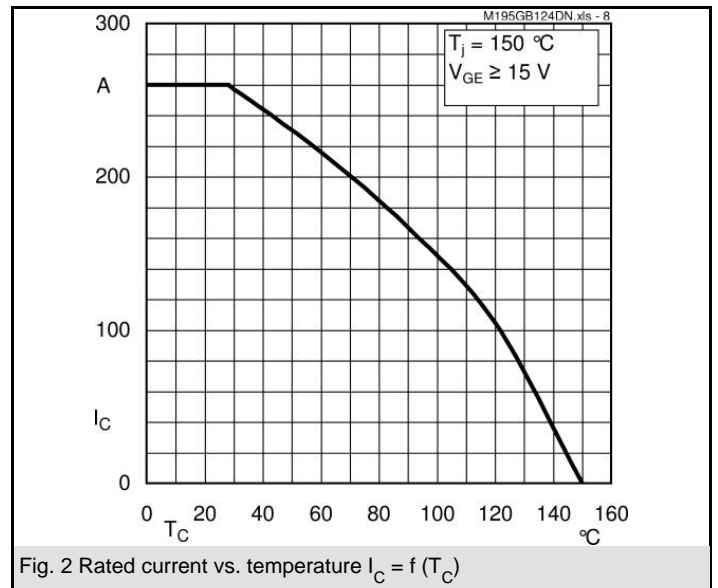
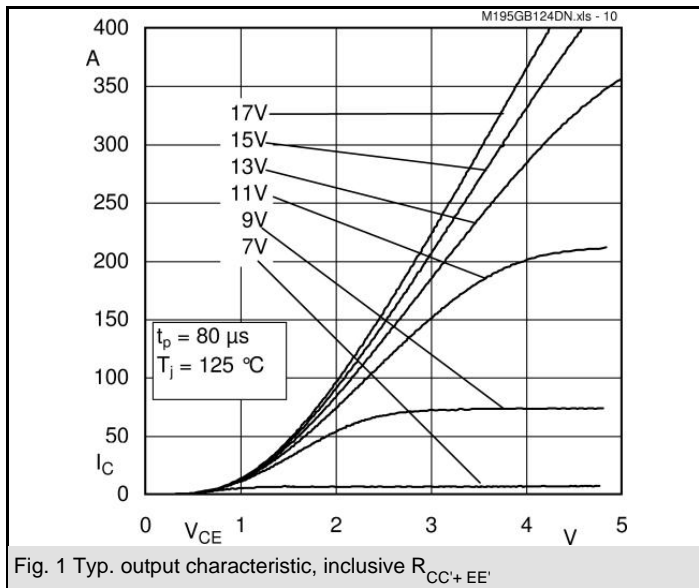
- Switching (not for linear use)
- Switched mode power supplies
- DC servo and robot drives
- Inverters
- DC choppers
- AC motor speed control
- UPS Uninterruptable power supplies
- General power switching applications
- Electronic (also portable) welders



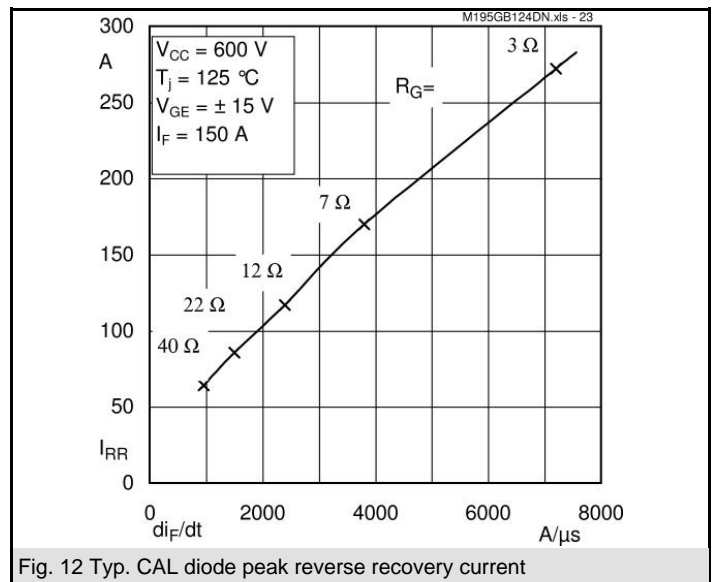
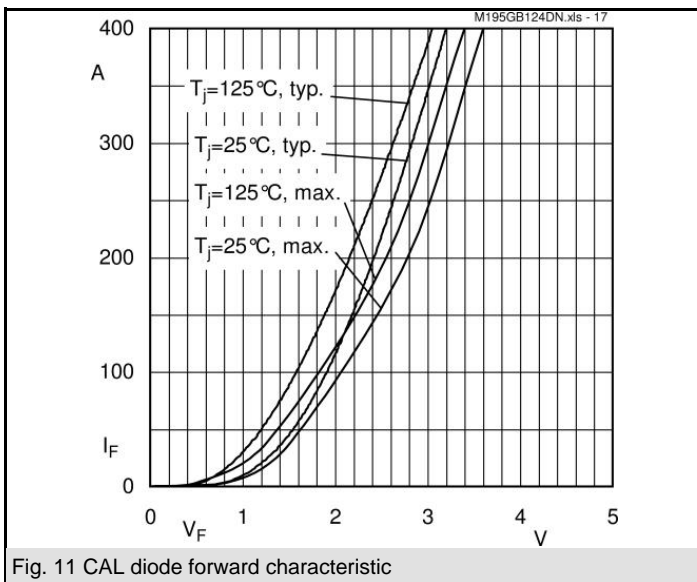
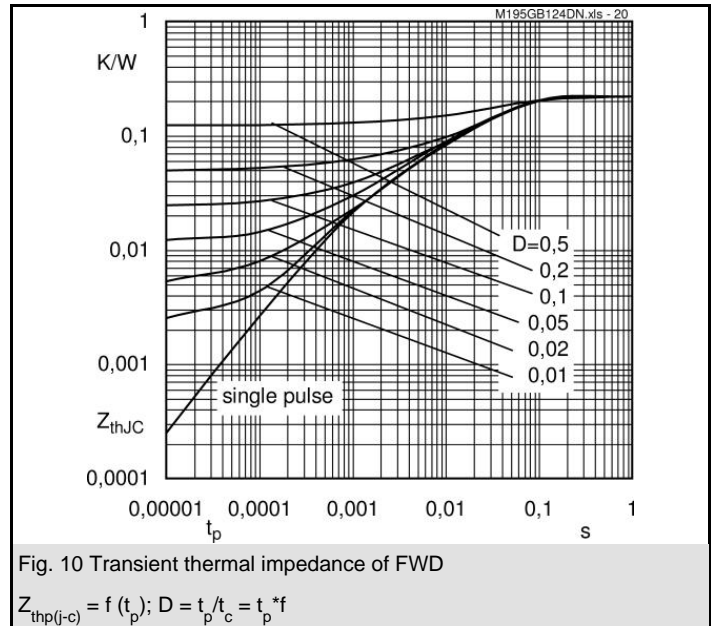
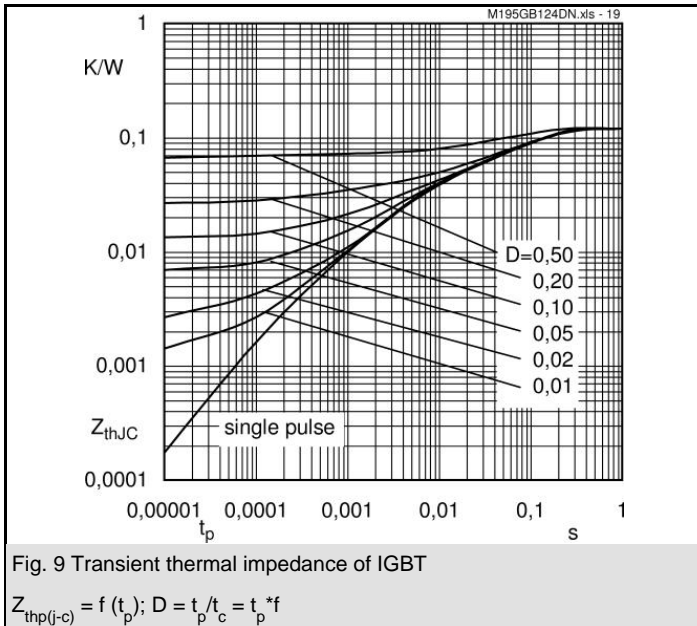
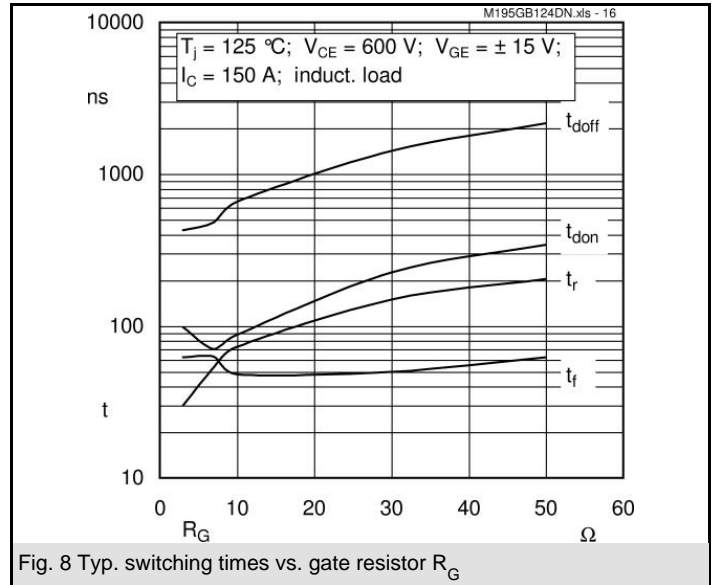
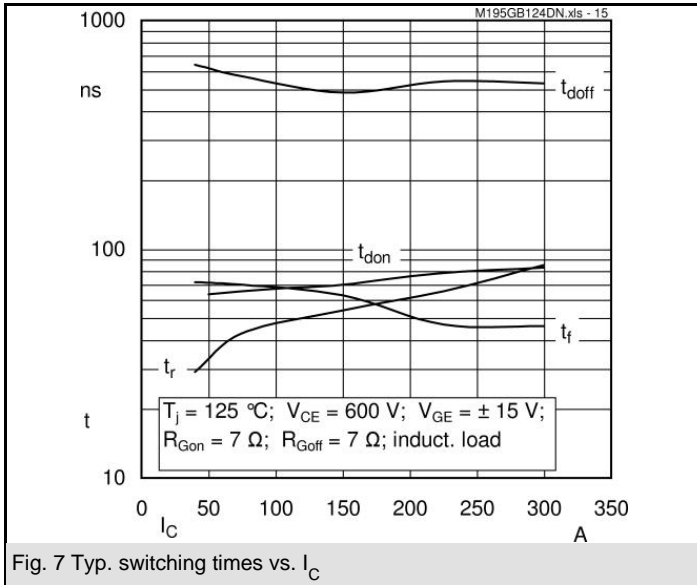
Absolute Maximum Ratings		$T_c = 25\text{ }^\circ\text{C}$, unless otherwise specified		
Symbol	Conditions	Values		Units
IGBT				
V_{CES}		1200		V
I_C	$T_c = 25\text{ (80) }^\circ\text{C}$	260 (180)		A
I_{CRM}	$T_c = 25\text{ (80) }^\circ\text{C}$, $t_p = 1\text{ ms}$	520 (360)		A
V_{GES}		± 20		V
T_{vj} , (T_{stg})	$T_{OPERATION} \leq T_{stg}$	- 40 ... + 150 (125)		$^\circ\text{C}$
V_{isol}	AC, 1 min.	2500		V
Inverse diode				
I_F	$T_c = 25\text{ (80) }^\circ\text{C}$	200 (160)		A
I_{FRM}	$T_c = 25\text{ (80) }^\circ\text{C}$, $t_p = 1\text{ ms}$	520 (360)		A
I_{FSM}	$t_p = 10\text{ ms}$; sin.; $T_j = 150\text{ }^\circ\text{C}$	1450		A

Characteristics		$T_c = 25\text{ }^\circ\text{C}$, unless otherwise specified			
Symbol	Conditions	min.	typ.	max.	Units
IGBT					
$V_{GE(th)}$	$V_{GE} = V_{CE}$, $I_C = 6\text{ mA}$	4,5	5,5	6,5	V
I_{CES}	$V_{GE} = 0$, $V_{CE} = V_{CES}$, $T_j = 25\text{ (125) }^\circ\text{C}$		0,2	0,6	mA
$V_{CE(TO)}$	$T_j = 25\text{ (125) }^\circ\text{C}$		1,1 (1,1)	1,25 (1,25)	V
r_{CE}	$V_{GE} = 15\text{ V}$, $T_j = 25\text{ (125) }^\circ\text{C}$		6,66 (8,66)	8 (10,66)	m Ω
$V_{CE(sat)}$	$I_C = 150\text{ A}$, $V_{GE} = 15\text{ V}$, chip level		2,1 (2,4)	2,45 (2,85)	V
C_{ies}	under following conditions		11	15	nF
C_{oes}	$V_{GE} = 0$, $V_{CE} = 25\text{ V}$, $f = 1\text{ MHz}$		1,6	2	nF
C_{res}			0,8	1	nF
L_{CE}				25	nH
$R_{CC+EE'}$	res., terminal-chip $T_c = 25\text{ (125) }^\circ\text{C}$		0,75 (1)		m Ω
$t_{d(on)}$	$V_{CC} = 600\text{ V}$, $I_C = 150\text{ A}$		70		ns
t_r	$R_{Gon} = R_{Goff} = 7\text{ }^\circ\Omega$, $T_j = 125\text{ }^\circ\text{C}$		55		ns
$t_{d(off)}$	$V_{GE} = \pm 15\text{ V}$		490		ns
t_f			65		ns
$E_{on} (E_{off})$			26 (23)		mJ
Inverse diode					
$V_F = V_{EC}$	$I_F = 150\text{ A}$; $V_{GE} = 0\text{ V}$; $T_j = 25\text{ (125) }^\circ\text{C}$		2 (1,8)	2,5	V
$V_{(TO)}$	$T_j = 125\text{ () }^\circ\text{C}$		1,1	1,2	V
r_T	$T_j = 125\text{ () }^\circ\text{C}$			7	m Ω
I_{RRM}	$I_F = 150\text{ A}$; $T_j = 125\text{ () }^\circ\text{C}$		87		A
Q_{rr}	$di/dt = 1500\text{ A}/\mu\text{s}$		19		μC
E_{rr}	$V_{GE} = V$				mJ
FWD					
$V_F = V_{EC}$	$I_F = 150\text{ A}$; $V_{GE} = 0\text{ V}$, $T_j = 25\text{ (125) }^\circ\text{C}$		2 (1,8)		V
$V_{(TO)}$	$T_j = 125\text{ () }^\circ\text{C}$		1,1	1,2	V
r_T	$T_j = 125\text{ () }^\circ\text{C}$			7	m Ω
I_{RRM}	$I_F = 150\text{ A}$; $T_j = 125\text{ () }^\circ\text{C}$		87		A
Q_{rr}	$di/dt = 0\text{ A}/\mu\text{s}$		19		μC
E_{rr}	$V_{GE} = V$				mJ
Thermal characteristics					
$R_{th(j-c)}$	per IGBT			0,12	K/W
$R_{th(j-c)D}$	per Inverse Diode			0,23	K/W
$R_{th(c-s)}$	per module			0,05	K/W
Mechanical data					
M_s	to heatsink M6	3		5	Nm
M_t	to terminals M5	2,5		5	Nm
w				160	g

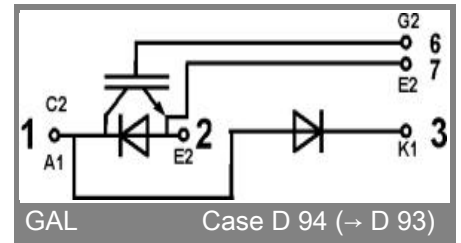
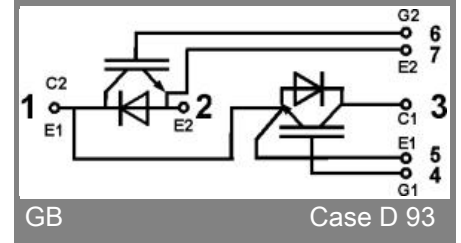
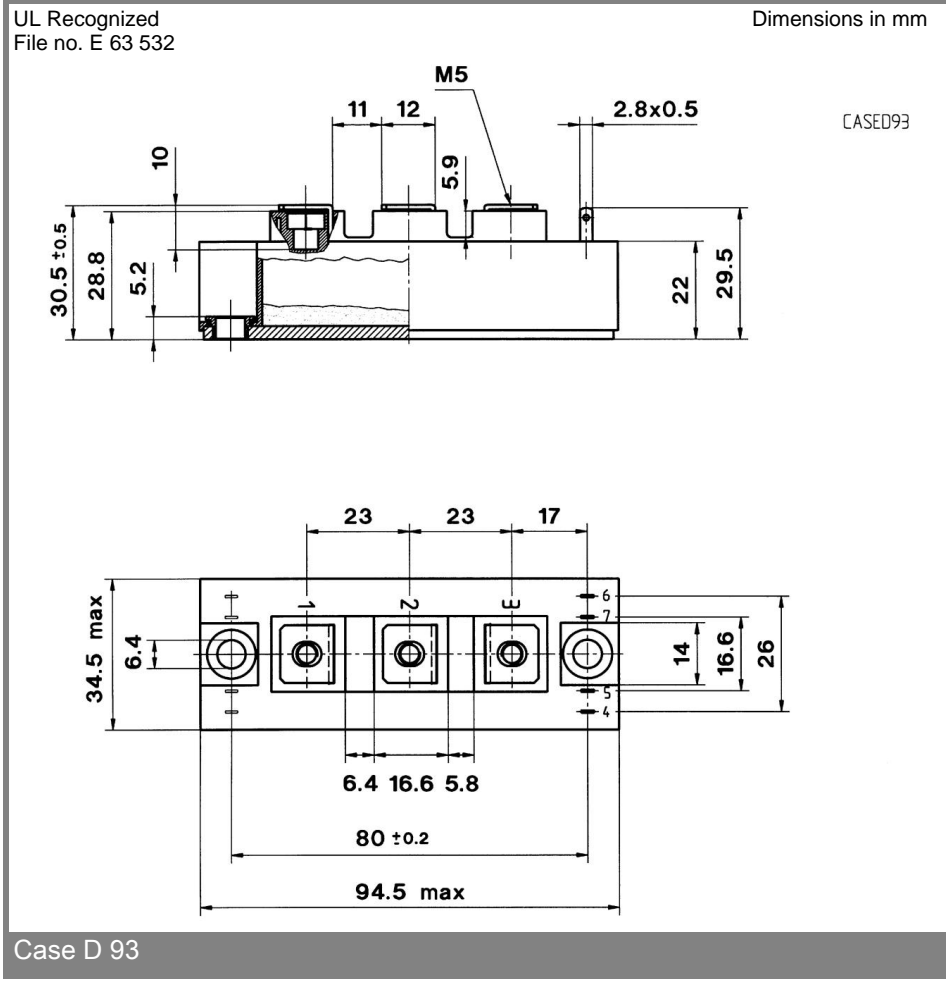
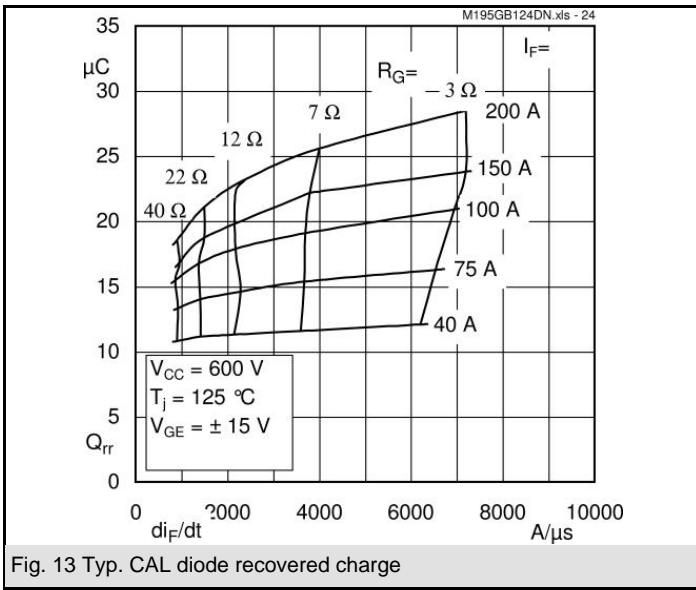
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This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

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